3.0mmx1.0mm RIGHT ANGLE SMD CHIP LED LAMP



Features

• Ideal for indication light on hand held products

• Long life and robust package

• Standard Package: 2,000pcs/ Reel

 \bullet MSL (Moisture Sensitivity Level): 3

• RoHS compliant

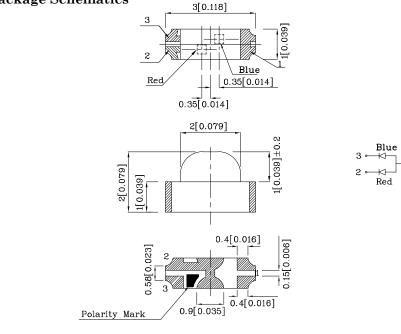






ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Package Schematics



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.15(0.006")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T_A =25°C)		Red (AlGaInP)	Blue (InGaN)	Unit
Reverse Voltage	$V_{\rm R}$	5	5	V
Forward Current	I_{F}	30	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	185	150	mA
Power Dissipation	P_{D}	75	120	mW
Electrostatic Discharge Threshold (HBM)		3000	250	V
Operating Temperature	$T_{\rm A}$	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +85		

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Red (AlGaInP)	Blue (InGaN)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	1.95	3.3	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	4	V
Reverse Current (Max.) $(V_R=5V)$	I_R	10	50	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =20mA)	λP	645*	460*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =20mA)	λD	630*	465*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	28	25	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	35	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZMDKCBD56W	Red	AlGaInP	- Water Clear	120 40*	297 79*	645*	140°
	Blue	InGaN	- water Clear	40 40*	89 89*	460*	

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

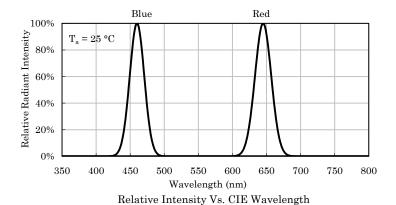
Oct 17,2018

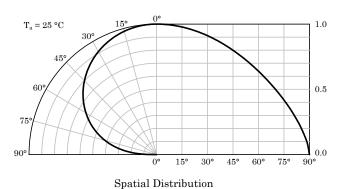
XDSB6207 V6-X Layout: Maggie L.

3.0mmx1.0mm RIGHT ANGLE SMD CHIP LED

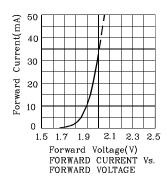
LAMP

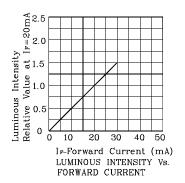


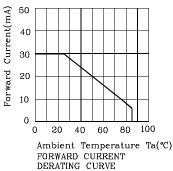


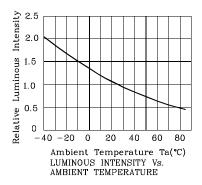


❖ Red

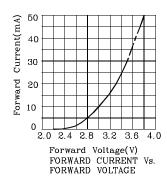


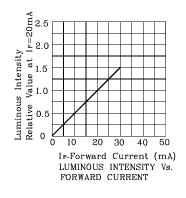


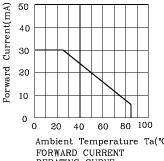




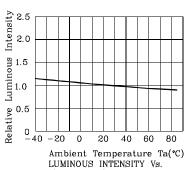
Blue







Ambient Temperature Ta(°C) DERATING CURVE



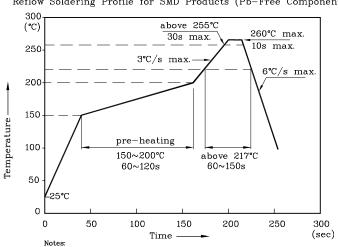
AMBIENT TEMPERATURE

LAMP

LED is recommended for reflow soldering and soldering profile is shown below.

www.SunLEDusa.com

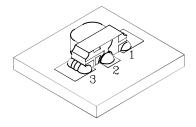
Reflow Soldering Profile for SMD Products (Pb-Free Components)



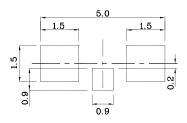
- 1. All temperatures refer to the center of the package, measured on the package body surface facing up during reflow.
- 2. Do not apply any stress to the LED during high temperature conditions.

 3. Maximum number of soldering passes: 2

❖ The device has a single mounting surface. The device must be mounted according to the specifications.



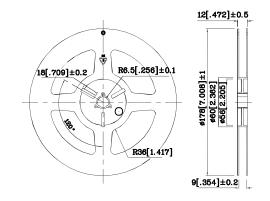
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Tape Specification (Units:mm)

TAPE 4.0 ± 0.1 1.75 ± 0.1 2.0 ± 0.1 4.0 ± 0.1 Ø1.5±0.1 0.23±0.1 1.2 ± 0.1 3.5 ± 0.05 8.0 ± 0.3

Reel Dimension



Remarks:

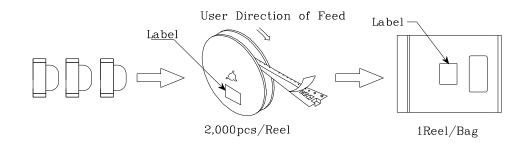
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

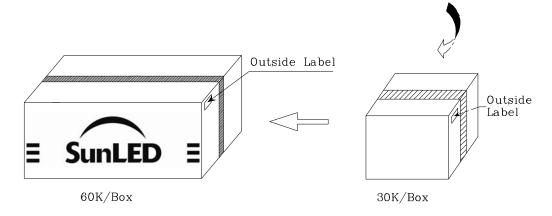
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

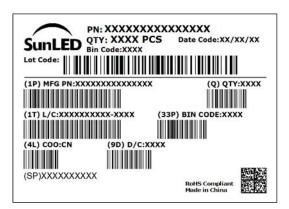
Note: Accuracy may depend on the sorting parameters.

 $3.0 \mathrm{mmx} 1.0 \mathrm{mm}$ RIGHT ANGLE SMD CHIP LED LAMP

PACKING & LABEL SPECIFICATIONS







TERMS OF USE

- $1. \ Data \ presented \ in \ this \ document \ reflect \ statistical \ figures \ and \ should \ be \ treated \ as \ technical \ reference \ only.$
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp

XDSB6207 V6-X Layout: Maggie L.